

Inductors for power circuits Wound metal **SPM** series









SPM6530 type













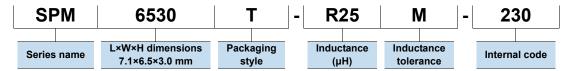
FEATURES

- Magnetic shield type wound inductor for power circuits using a metallic magnetic material.
- Ocmpared to ferrite wound type inductors, it is possible to achieve large current, low Rdc, and compactness.
- O Low inductance variance in high-temperature environments with good DC superimposition characteristics.
- O Metallic magnetic material is used, and the structure has an integrated molded coil, so hum noise is lower than with core adhesive coils.
- Operating temperature range: -40 to +125 °C (including self-temperature rise)

APPLICATION

O Note PCs, HDDs, servers, VRMs, compact power supply modules, other

PART NUMBER CONSTRUCTION



CHARACTERISTICS SPECIFICATION TABLE

L		LMeasuring frequency	DC resistance	DC resistance		rent*	Part No.
(µH)	Tolerance	(kHz)	(mΩ)max.	(mΩ)typ.	lsat (A)typ.	Itemp (A)typ.	
0.25	±20%	100	2.31	2.10	28.5	23.0	SPM6530T-R25M230
0.47	±20%	100	3.63	3.30	20.5	20.0	<u>SPM6530T-R47M170</u>
0.56	±20%	100	3.63	3.30	20.5	20.0	<u>SPM6530T-R56M</u>
0.68	±20%	100	5.39	4.90	16.6	16.0	SPM6530T-R68M140
1.0	±20%	100	7.81	7.10	14.1	13.0	SPM6530T-1R0M120
1.5	±20%	100	10.7	9.70	11.5	11.0	SPM6530T-1R5M100
2.2	±20%	100	19.1	17.3	8.4	8.2	SPM6530T-2R2M
3.3	±20%	100	29.7	27.0	7.3	6.8	<u>SPM6530T-3R3M</u>
4.7	±20%	100	39.4	35.8	6.2	5.6	<u>SPM6530T-4R7M</u>
6.8	±20%	100	53.3	48.4	4.0	4.0	<u>SPM6530T-6R8M</u>
10	±20%	100	72.5	65.9	3.8	3.6	SPM6530T-100M

^{*} Rated current: smaller value of either Isat or Itemp.

Isat: When based on the inductance change rate (20% below the initial value)

Itemp: When based on the temperature increase (temperature increase of 40°C by self heating)

■ Measurement equipment

Measurement item	Product No.	Manufacturer
L	4284A	Keysight Technologies
DC resistance	AX-111A	ADEX
Rated current Isat	4284A+42841A+42842C	Keysight Technologies

^{*} Equivalent measurement equipment may be used.

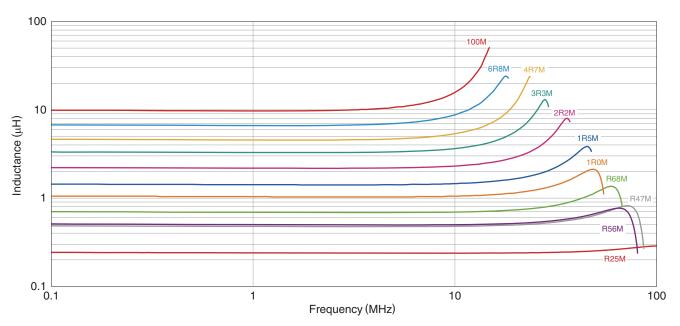


[•] The cleaning agent can not be used for these products.



SPM6530 type

■ L FREQUENCY CHARACTERISTICS

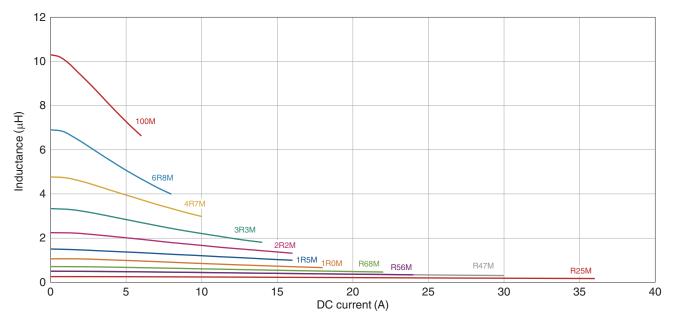


■ Measurement equipment

Product No.	Manufacturer
4294A	Keysight Technologies

^{*} Equivalent measurement equipment may be used.

■ INDUCTANCE VS. DC BIAS CHARACTERISTICS



☐ Measurement equipment

Product No.	Manufacturer
4284A+42841A+42842C	Keysight Technologies

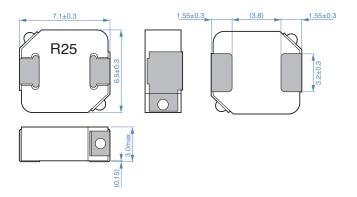
A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

^{*} Equivalent measurement equipment may be used.

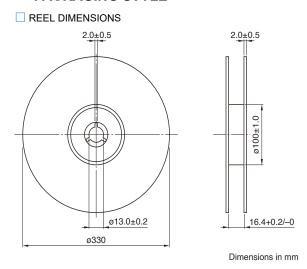


SPM6530 type

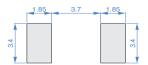
■ SHAPE & DIMENSIONS



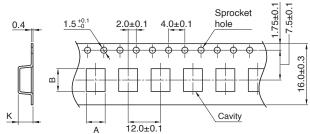
■ PACKAGING STYLE



RECOMMENDED LAND PATTERN



☐ TAPE DIMENSIONS



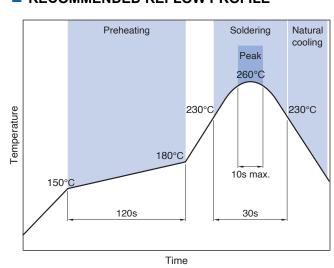
Dimensions in mm

Туре	Α	В	K
SPM6530	7.4	7.6	3.6

PACKAGE QUANTITY

LI AOIGOL QUAITITI	
Package quantity	1000 pcs/reel

■ RECOMMENDED REFLOW PROFILE



■ TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range *	Storage temperature range **	Individual weight
-40 to +125 °C	-40 to +125 °C	0.656 g

^{*} Operating temperature range includes self-temperature rise.

^{**} The storage temperature range is for after the assembly.



REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products

REMINDERS

The storage period is within 12 months. Be sure to f less).	follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH o
If the storage period elapses, the soldering of the term	ninal electrodes may deteriorate.
On not use or store in locations where there are conditions.	itions such as gas corrosion (salt, acid, alkali, etc.).
 Before soldering, be sure to preheat components. The preheating temperature should be set so that th does not exceed 150°C. 	e temperature difference between the solder temperature and chip temperature
 Soldering corrections after mounting should be within If overheated, a short circuit, performance deterioration 	the range of the conditions determined in the specifications. on, or lifespan shortening may occur.
 When embedding a printed circuit board where a chip overall distortion of the printed circuit board and partia 	is mounted to a set, be sure that residual stress is not given to the chip due to the al distortion such as at screw tightening portions.
 Self heating (temperature increase) occurs when th design. 	e power is turned ON, so the tolerance should be sufficient for the set therma
Carefully lay out the coil for the circuit board design of A malfunction may occur due to magnetic interference	71
○ Use a wrist band to discharge static electricity in your	body through the grounding wire.
On not expose the products to magnets or magnetic f	ields.
On not use for a purpose outside of the contents regu	lated in the delivery specifications.
home appliances, amusement equipment, computer industrial robots) under a normal operation and use of the products are not designed or warranted to mee quality require a more stringent level of safety or relaciously, person or property.	e in general electronic equipment (AV equipment, telecommunications equipment requipment, personal equipment, office equipment, measurement equipment condition. Et the requirements of the applications listed below, whose performance and/o liability, or whose failure, malfunction or trouble could cause serious damage to sted below or if you have special requirements exceeding the range or conditions.
 (1) Aerospace/aviation equipment (2) Transportation equipment (cars, electric trains, shi (3) Medical equipment (4) Power-generation control equipment (5) Atomic energy-related equipment 	(7) Transportation control equipment ps, etc.) (8) Public information-processing equipment (9) Military equipment (10) Electric heating apparatus, burning equipment (11) Disaster prevention/crime prevention equipment

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

(12) Safety equipment

applications

(13) Other applications that are not considered general-purpose

(6) Seabed equipment